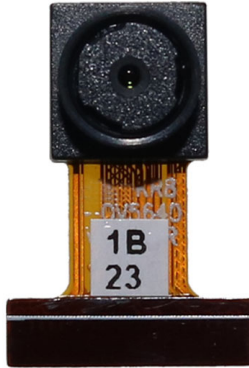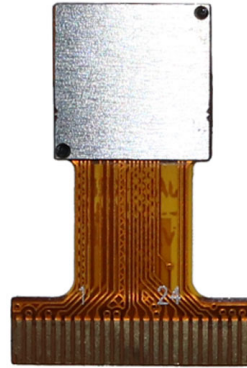## YDS-KR8-OV5640-1B V2.0 NIR
5MP OmniVision OV5640-1B DVP Parallel Interface No IR Filter Fixed Focus Camera Module

Front View   Back View

Specifications

Camera Module No.	YDS-KR8-OV5640-1B V2.0 NIR
Resolution	5MP
Image Sensor	OV5640-1B
Sensor Type	1/4"
Pixel Size	1.4 um x 1.4 um
EFL	3.29 mm
F.NO	2.80
Pixel	2592 x 1944
View Angle	68.7°(DFOV) 58.1°(HFOV) 45.0°(VFOV)
Lens Dimensions	8.00 x 8.00 x 4.77 mm
Module Size	18.50 x 12.50 mm
Module Type	Fixed Focus
Interface	DVP Parallel
Auto Focus VCM Driver IC	Embedded
Lens Model	YDS-LENS-M5101
Lens Type	No IR Filter Lens
Operating Temperature	-30°C to +70°C
Mating Connector	FH12-24S-0.5SH

YDS-KR8-OV5640-1B V2.0 NIR
5MP OmniVision OV5640-1B DVP Parallel Interface No IR Filter
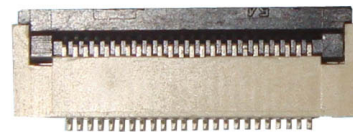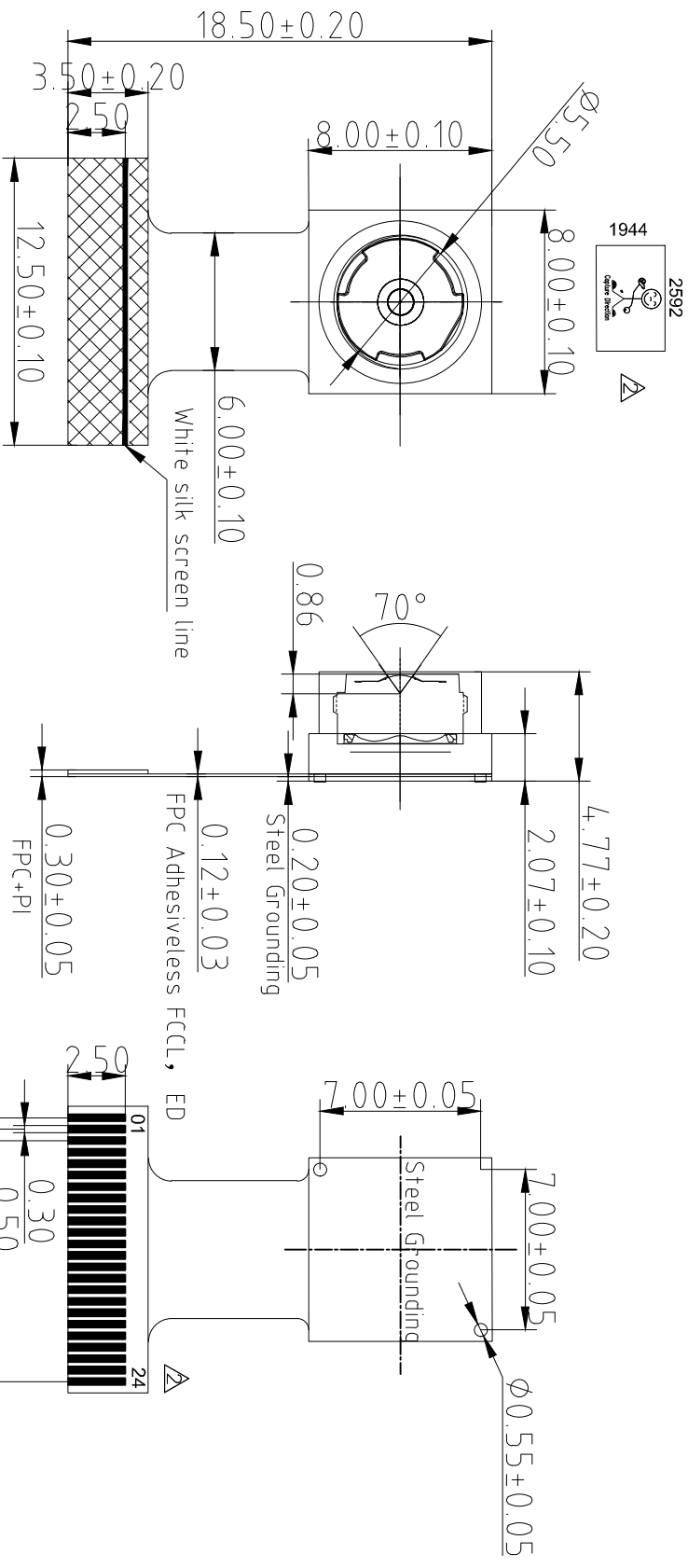## Fixed Focus Camera Module

Top View

Side View

Bottom View

Mating Connector

ROHS

PIN SIGNAL

PIN	SIGNAL
1	NC
2	AGND
3	SIO_D
4	AVDD 2.8V
5	SIO_C
6	RESET
7	VSYNC
8	PWDN
9	HREF
10	DVDD1.5V
11	DOVDD2.8V
12	D9
13	XCLK
14	D8
15	DGND
16	D7
17	PCLK
18	D6
19	D2
20	D5
21	D3
22	D4
23	D1
24	D0

Parameters:

1、Sensor specification:

Image Sensor: OV5640-1B
Pixel: 1.4um×1.4um
Lens Type: 1/4
Important Voltage Description: DVDD1.5V
(external power supply);

2、Lens specification:

FOV: 70°(D);58.6°(H);45.3°(V)
F/NO: 2.8
TV distortion: <1.0%
Focal length: 3.2mm
Composition: 4P

TOP VIEW

18.50±0.20
3.50±0.20
2.50
8.00±0.10
Ø5.50
8.00±0.10
12.50±0.10
6.00±0.10
White silk screen line

1944
2592
Capture Direction

SIDE VIEW

0.86
70°
4.77±0.20
2.07±0.10
0.20±0.05 Steel Grounding
0.12±0.03 FPC Adhesiveless FCCL, ED
0.30±0.05 FPC+PI

BOTTOM VIEW

2.50
01
0.30
0.50
11.50
24
7.00±0.05
7.00±0.05
Steel Grounding
Φ0.55±0.05

Version Mark		Information	
		First Version	Date
V1.0	PD	First Version	2016-03-12
V2.0		Change lens, the capture direction and the PIN order	2017-02-08

| Designed By | Kevin | Model Name: | KR8-OV5640-1B V2.0 NIR |
| Checked By | Aouly Yan | | |

Projection Type: Third Angle
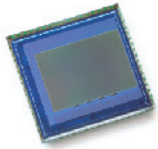Unit: mm
Material: ----------
Scale: 1:1
Sheet: 1 of 1
Version: 1/0

OV5640 5-megapixel product brief

1/4-inch, 5-Megapixel SOC Image Sensor
Optimized for High-Volume Mobile Markets

lead free

available in
a lead-free
package

The OV5640 delivers a complete 5-megapixel camera solution on a single chip, aimed at offering cost efficiencies that serve the high-volume autofocus (AF) camera phone market. The system-on-a-chip (SOC) sensor features OmniVision's 1.4 micron OmniBSI™ backside illumination architecture to deliver excellent pixel performance and best-in-class low-light sensitivity, while enabling ultra compact camera module designs of 8.5 mm x 8.5 mm with <6 mm z-height. The OV5640 provides the full functionality of a complete camera, including anti-shake technology, AF control, and MIPI while being easier to tune then two-chip solutions, making it an ideal choice in terms of cost, time-to-market and ease of platform integration.

The OV5640 enables 720p HD video at 60 frames per second (fps) and 1080p HD video at 30 fps with complete user control over formatting and output data transfer. The 720p/60 HD video is captured in full field of view (FOV) with 2 x 2 binning, which doubles the sensitivity and improves the signal-to-noise ratio (SNR). Additionally, a unique post-binning re-sampling filter function removes zigzag artifacts around slant edges and minimizes spatial artifacts to deliver even sharper, crisper

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Find out more at www.ovt.com.

OmniVision

applications

- cellular phones
- toys
- PC multimedia
- digital still cameras
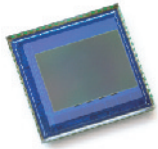
ordering information

- **OV05640-A71A-1B** (color, lead-free)
  71-pin CSP

features

- 1.4 µm x 1.4 µm pixel with OmniBSI technology for high performance (high sensitivity, low crosstalk, low noise, improved quantum efficiency)
- optical size of 1/4"
- automatic image control functions: automatic exposure control (AEC), automatic white balance (AWB), automatic band filter (ABF), automatic 50/60 Hz luminance detection, and automatic black level calibration (ABLC)
- programmable controls for frame rate, AEC/AGC 16-zone size/position/weight control, mirror and flip, cropping, windowing, and panning
- image quality controls: color saturation, hue, gamma, sharpness (edge enhancement), lens correction, defective pixel canceling, and noise canceling
- support for output formats: RAW RGB, RGB565/555/444, CCIR656, YUV422/420, YCbCr422, and compression
- support for video or snapshot operations
- support for internal and external frame synchronization for frame exposure mode

- support for LED and flash strobe mode
- support for horizontal and vertical sub-sampling, binning
- support for minimizing artifacts on binned image
- support for data compression output
- support for anti-shake
- standard serial SCCB interface
- digital video port (DVP) parallel output interface and dual lane MIPI output interface
- embedded 1.5V regulator for core power
- programmable I/O drive capability, I/O tri-state configurability
- support for black sun cancellation
- support for images sizes: 5 megapixel, and any arbitrary size scaling down from 5 megapixel
- support for auto focus control (AFC) with embedded AF VCM driver
- embedded microcontroller
- suitable for module size of 8.5 x 8.5 x <6mm with both CSP and RW packaging

key specifications (typical)

- **active array size:** 2592 x 1944
- **power supply:**
  core: 1.425 ~ 1.675V (with embedded 1.5V regulator)
  analog: 2.6 ~ 3.0V (2.8V typical)
  I/O: 1.8V / 2.8V
- **power requirements:**
  active: 140 mA
  standby: 20 µA
- **temperature range:**
  operating: -30°C to 70°C junction temperature (see **table 8-2**)
  stable image: 0°C to 50°C junction temperature (see **table 8-2**)
- **output formats:** 8-/10-bit RGB RAW output
- **lens size:** 1/4"
- **lens chief ray angle:** 24° (see **figure 10-2**)

- **input clock frequency:** 6~27 MHz
- **max S/N ratio:** 36 dB
- **dynamic range:** 68 dB @ 8x gain
- **maximum image transfer rate:**
  QSXGA (2592x1944): 15 fps
  1080p: 30 fps
  1280x960: 45 fps
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- **shutter:** rolling shutter / frame exposure
- **maximum exposure interval:** 1964 x t_{ROW}
- **pixel size:** 1.4 µm x 1.4 µm
- **dark current:** 8 mV/s @ 60°C junction temperature
- **image area:** 3673.6 µm x 2738.4 µm
- **package dimensions:** 5985 µm x 5835 µm

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Optimized for High-Volume Mobile Markets

available in
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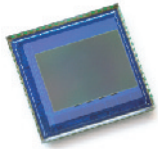
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Camera Module Pinout Definition Reference Chart

OmniVision Sony Samsung On-Semi Aptina Himax GalaxyCore PixArt SmartSens Sensors	
Pin Signal	**Description**
DGND GND	ground for digital circuit
AGND	ground for analog circuit
PCLK DCK	DVP PCLK output
XCLR PWDN XSHUTDOWN STANDBY	power down active high with internal pull-down resistor
MCLK XVCLK XCLK INCK	system input clock
RESET RST	reset active low with internal pull-up resistor
NC NULL	no connect
SDA SIO_D SIOD	SCCB data
SCL SIO_C SIOC	SCCB input clock
VSYNC XVS FSYNC	DVP VSYNC output
HREF XHS	DVP HREF output
DOVDD	power for I/O circuit
AFVDD	power for VCM circuit
AVDD	power for analog circuit
DVDD	power for digital circuit
STROBE FSTROBE	strobe output
FSIN	synchronize the VSYNC signal from the other sensor
SID	SCCB last bit ID input
ILPWM	mechanical shutter output indicator
FREX	frame exposure / mechanical shutter
GPIO	general purpose inputs
SLASEL	I2C slave address select
AFEN	CEN chip enable active high on VCM driver IC
MIPI Interface	
MDN0 DN0 MD0N DATA_N DMO1N	MIPI 1st data lane negative output
MDP0 DP0 MD0P DATA_P DMO1P	MIPI 1st data lane positive output
MDN1 DN1 MD1N DATA2_N DMO2N	MIPI 2nd data lane negative output
MDP1 DP1 MD1P DATA2_P DMO2P	MIPI 2nd data lane positive output
MDN2 DN2 MD2N DATA3_N DMO3N	MIPI 3rd data lane negative output
MDP2 DP2 MD2P DATA3_P DMO3P	MIPI 3rd data lane positive output
MDN3 DN3 MD3N DATA4_N DMO4N	MIPI 4th data lane negative output
MDP3 DP3 MD3P DATA4_P DMO4P	MIPI 4th data lane positive output
MCN CLKN CLK_N DCKN	MIPI clock negative output
MCP CLKP MCP CLK_P DCKN	MIPI clock positive output
DVP Parallel Interface	
D0 DO0 Y0	DVP data output port 0
D1 DO1 Y1	DVP data output port 1
D2 DO2 Y2	DVP data output port 2
D3 DO3 Y3	DVP data output port 3
D4 DO4 Y4	DVP data output port 4
D5 DO5 Y5	DVP data output port 5
D6 DO6 Y6	DVP data output port 6
D7 DO7 Y7	DVP data output port 7
D8 DO8 Y8	DVP data output port 8
D9 DO9 Y9	DVP data output port 9
D10 DO10 Y10	DVP data output port 10
D11 DO11 Y11	DVP data output port 11

your best camera partner

Cameras Applications

Camera Reliability Test

Reliability Inspection Item		Testing Method	Acceptance Criteria
Category	Item		
Environmental	Storage Temperature — High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation
Environmental	Storage Temperature — Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation
Environmental	Operation Temperature — High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation
Environmental	Operation Temperature — Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation
Environmental	Humidity — 60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation
Environmental	Thermal Shock — High 60°C 0.5 Hours / Low -20°C 0.5 Hours / Cycling in 24 Hours	Temperature Chamber	No Abnormal Situation
Physical	Drop Test (Free Falling) — Without Package 60cm	10 Times on Wood Floor	Electrically Functional
Physical	Drop Test (Free Falling) — With Package 60cm	10 Times on Wood Floor	Electrically Functional
Physical	Vibration Test — 50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional
Physical	Vibration Test — 50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional
Physical	Vibration Test — 50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional
Physical	Cable Tensile Strength Test — Loading Weight 4 kg / 60 Seconds / Cycling in 24 Hours	Tensile Testing Machine	Electrically Functional
Electrical	ESD Test — Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional
Electrical	ESD Test — Air Discharge 4 KV	ESD Testing Machine	Electrically Functional
Electrical	Aging Test — On/Off 30 Seconds / Cycling in 24 Hours	Power Switch	Electrically Functional
Electrical	USB Connector — On/Off 250 Times	Plug and Unplug	Electrically Functional

YDS CAMERA MODULE

Camera Inspection Standard

Inspection Item		Inspection Method	Standard of Inspection
Category	Item		
Appearance	FPC/ PCB — Color	The Naked Eye	Major Difference is Not Allowed.
	FPC/ PCB — Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.
	FPC/ PCB — Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)
	Holder — Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed
	Holder — Gap	The Naked Eye	Meet the Height Standard
	Holder — Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)
	Holder — Damage	The Naked Eye	The Inside Crack Exposure is Not Allowed
	Lens — Scratch	The Naked Eye	No Effect On Resolution Standard
	Lens — Contamination	The Naked Eye	No Effect On Resolution Standard
	Lens — Oil Film	The Naked Eye	No Effect On Resolution Standard
	Lens — Cover Tape	The Naked Eye	No Issue On Appearance.
Function	Image — No Communication	Test Board	Not Allowed
	Image — Bright Pixel	Black Board	Not Allowed In the Image Center
	Image — Dark Pixel	White board	Not Allowed In the Image Center
	Image — Blurry	The Naked Eye	Not Allowed
	Image — No Image	The Naked Eye	Not Allowed
	Image — Vertical Line	The Naked Eye	Not Allowed
	Image — Horizontal Line	The Naked Eye	Not Allowed
	Image — Light Leakage	The Naked Eye	Not Allowed
	Image — Blinking Image	The Naked Eye	Not Allowed
	Image — Bruise	Inspection Jig	Not Allowed
	Image — Resolution	Chart	Follows Outgoing Inspection Chart Standard
	Image — Color	The Naked Eye	No Issue
	Image — Noise	The Naked Eye	Not Allowed
	Image — Corner Dark	The Naked Eye	Less Than 100px By 100px
	Image — Color Resolution	The Naked Eye	No Issue
Dimension	Height	The Naked Eye	Follows Approval Data Sheet
	Width	The Naked Eye	Follows Approval Data Sheet
	Length	The Naked Eye	Follows Approval Data Sheet
	Overall	The Naked Eye	Follows Approval Data Sheet

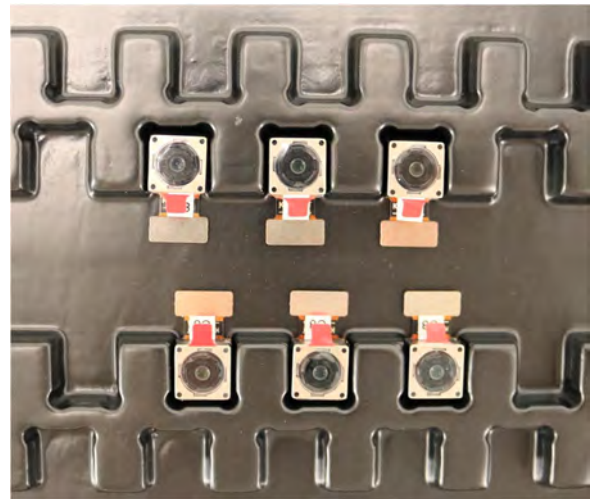## YDSCAM Package Solutions

YDS Camera Module

Complete with Lens Protection Film
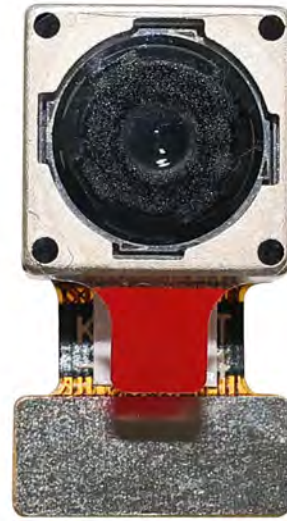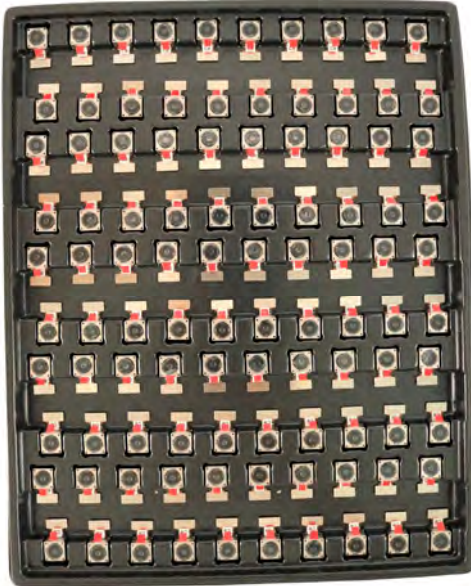

Tray with Grid and Space
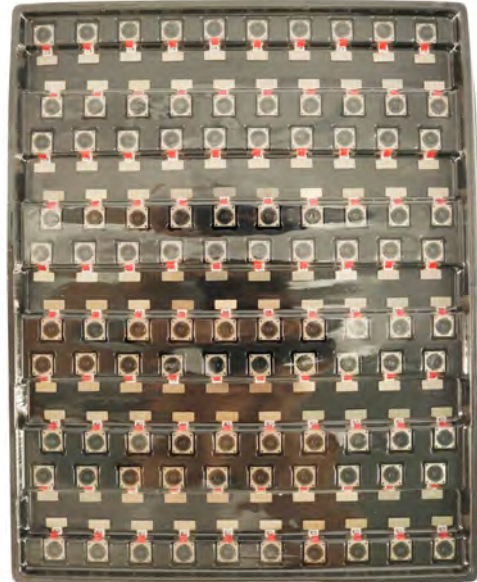
Place Cameras on the Tray

YDSCAM Package Solutions

Full Tray of Cameras

Cover Tray with Lid

Place Tray into Anti-Static Bag

Vacuum the Anti-Static Bag

YDSCAM Package Solutions

Sealed Vacuum Anti-Static Bag with Labels

1. Model and Description   2. Quantity   3. Manufacturing Date Code 4. Caution

YDS
YDS CAMERA

YDS Model No.

YDS-MAA12-IMX586 V1.0

IMX586, MIPI Interface

Auto Focus, 79.4 Degree

www.ydscam.com MADE IN CHINA

YDS
YDS CAMERA

Tray 1 of 1
100 PIECES

Production Date
20 August 2022

Date Code
2234 (Week 34, 2022)

www.ydscam.com MADE IN CHINA

CAUTION
STATIC SENSITIVE
DEVICES

NOT TO BE HANDLED
BY UNAUTHORISED
PERSONNEL

www.YDSCAM.com   sales@ydscam.com   Phone (WeChat, QQ): (+86) 177 2732 6718

YDSCAM Package Solutions

Place Foam Sheets Between Tray Bags

Foam Sheets are Larger Than Trays

Place Foam Sheets and Trays into Box

Foam Sheets are Tightly Fitting in Box

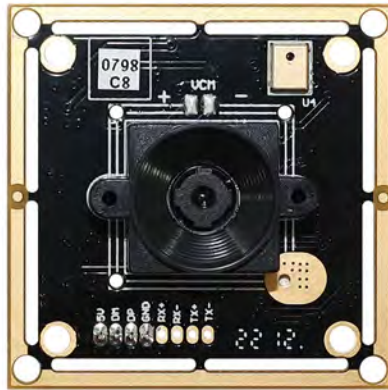**Seal the Carbon Box**

Label the Carbon Shipping Box

Package:

1 of 1

fragile
HANDLE WITH CARE

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YDSCAM Package Solutions

USB Camera Module

Complete with Lens Protection Film

Place Camera Sample into Anti-Static Bag

Place USB Cameras into Tray

Seal the Tray with Anti-Static Bag

Label the Carbon Shipping Box

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YDSCAM Package Solutions

Place Camera Sample into Anti-Static Bag

Place Connectors into Anti-Static Bag

Label the Sample Bags

Place Connectors into Reel

Place Samples into the Carbon Box


Place Connectors into the Carbon Box

Company YDSCAM

YingDeShun Co. Ltd. (YDS) was established in 2017, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. YDS is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

YDS provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. YDS specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.

USB camera module
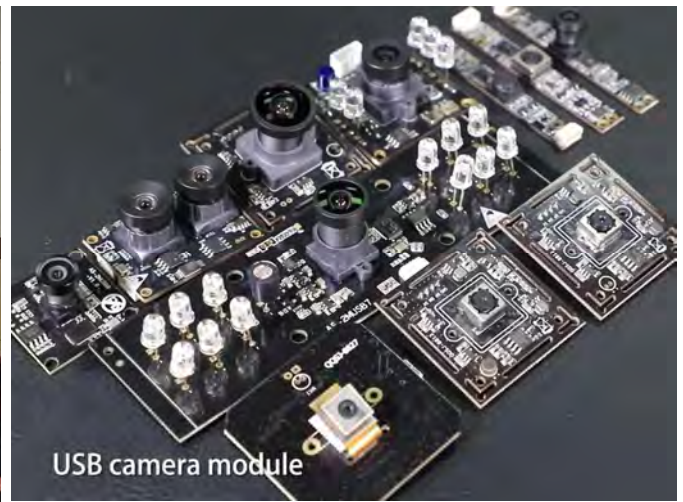
Limited Warranty

YDS provides the following limited warranty if you purchased the Product(s) directly from YDS company or from YDS's website www.YDSCAM.com. Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. YDS guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, YDS will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of YDS is solely limited to repair and/or replacement on the terms set forth above. YDS is not reliable or responsible for any subsequential events.

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YDS Strength

Powerful Factory

Professional Service

Promised Delivery